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(12) **United States Design Patent**
Park et al.

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(45) **Date of Patent:** **** Oct. 18, 2022**

(54) **WIRELESS EARBUD**
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(73) Assignee: **LG ELECTRONICS INC.**, Seoul (KR)
(**) Term: **15 Years**

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Int. Reg. Date: **Mar. 4, 2021**
Int. Reg. Pub. Date: **Sep. 10, 2021**

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Primary Examiner — Paula Allen Greene
(74) *Attorney, Agent, or Firm* — Birch, Stewart, Kolasch & Birch, LLP

(30) **Foreign Application Priority Data**
Oct. 14, 2020 (KR) 30-2020-0049209
(51) **LOC (13) Cl.** **14-01**
(52) **U.S. Cl.**
USPC **D14/223**
(58) **Field of Classification Search**
USPC D14/223, 205; D13/108; D24/174;
128/864–866; 381/380–381, 322, 328
CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1016; H04R 1/1066; H04R
5/033; H04R 5/0335
See application file for complete search history.

(57) **CLAIM**

The ornamental design for a wireless earbud, as shown and described.

DESCRIPTION

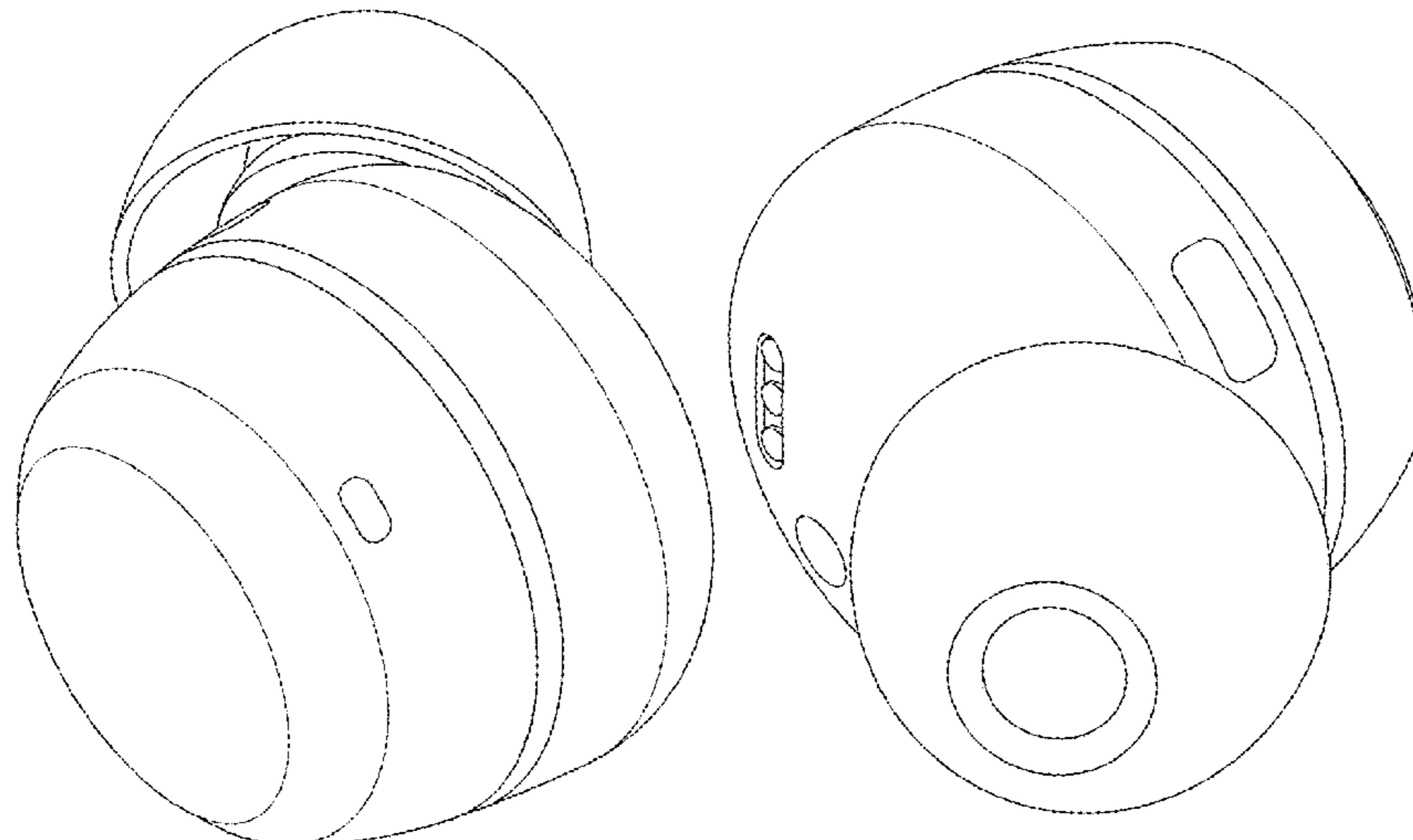
- 1. Wireless earbud
- 1.1 : Front perspective
- 1.2 : Rear perspective
- 1.3 : Front
- 1.4 : Back
- 1.5 : Left
- 1.6 : Right
- 1.7 : Top
- 1.8 : Bottom
- 1.9 : Reference

Reproduction **1.9** is a reference view showing a use state of the claimed design; the parts shown by means of broken lines in reproduction **1.9** are not part of the claimed design.

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1 Claim, 9 Drawing Sheets



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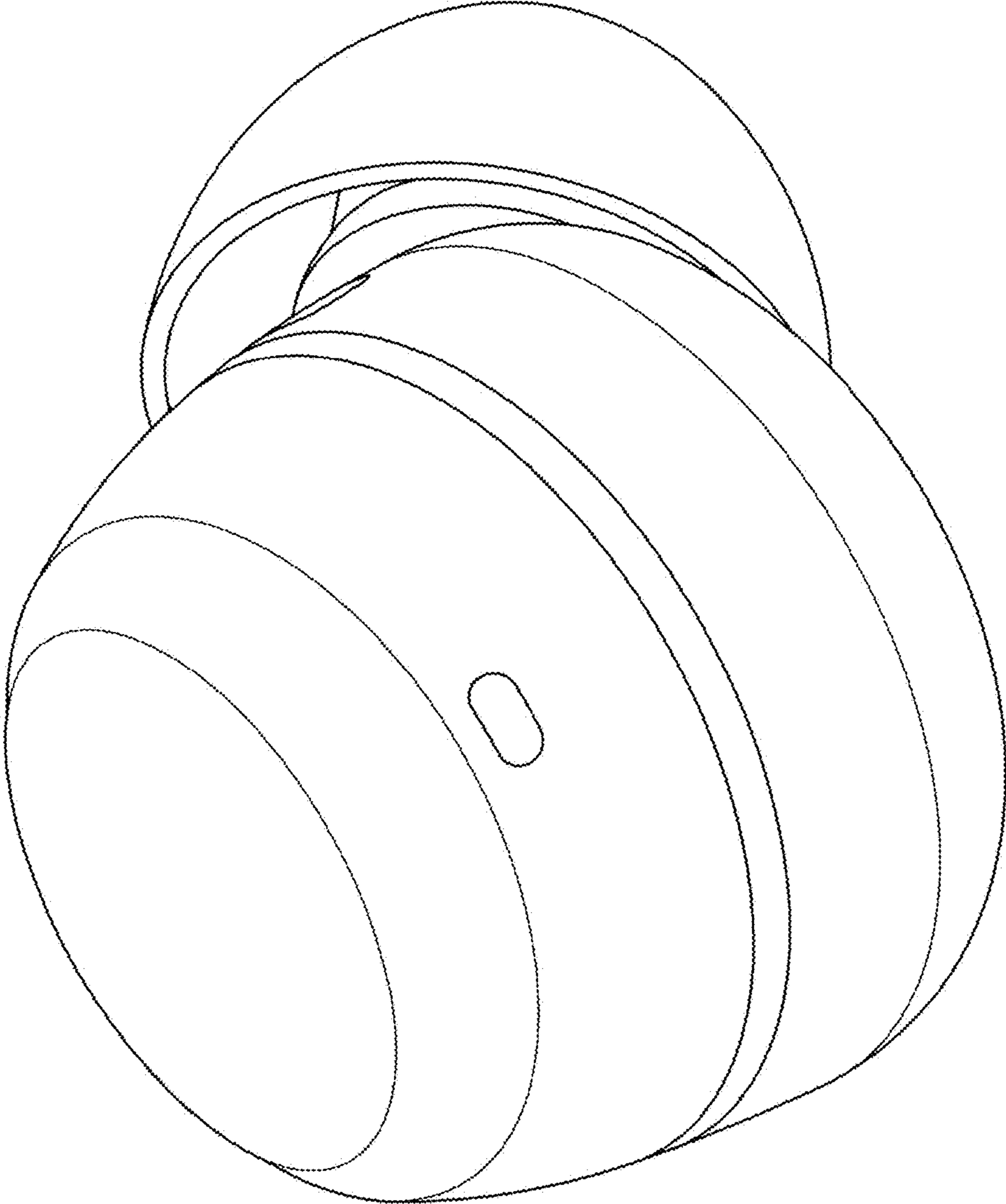
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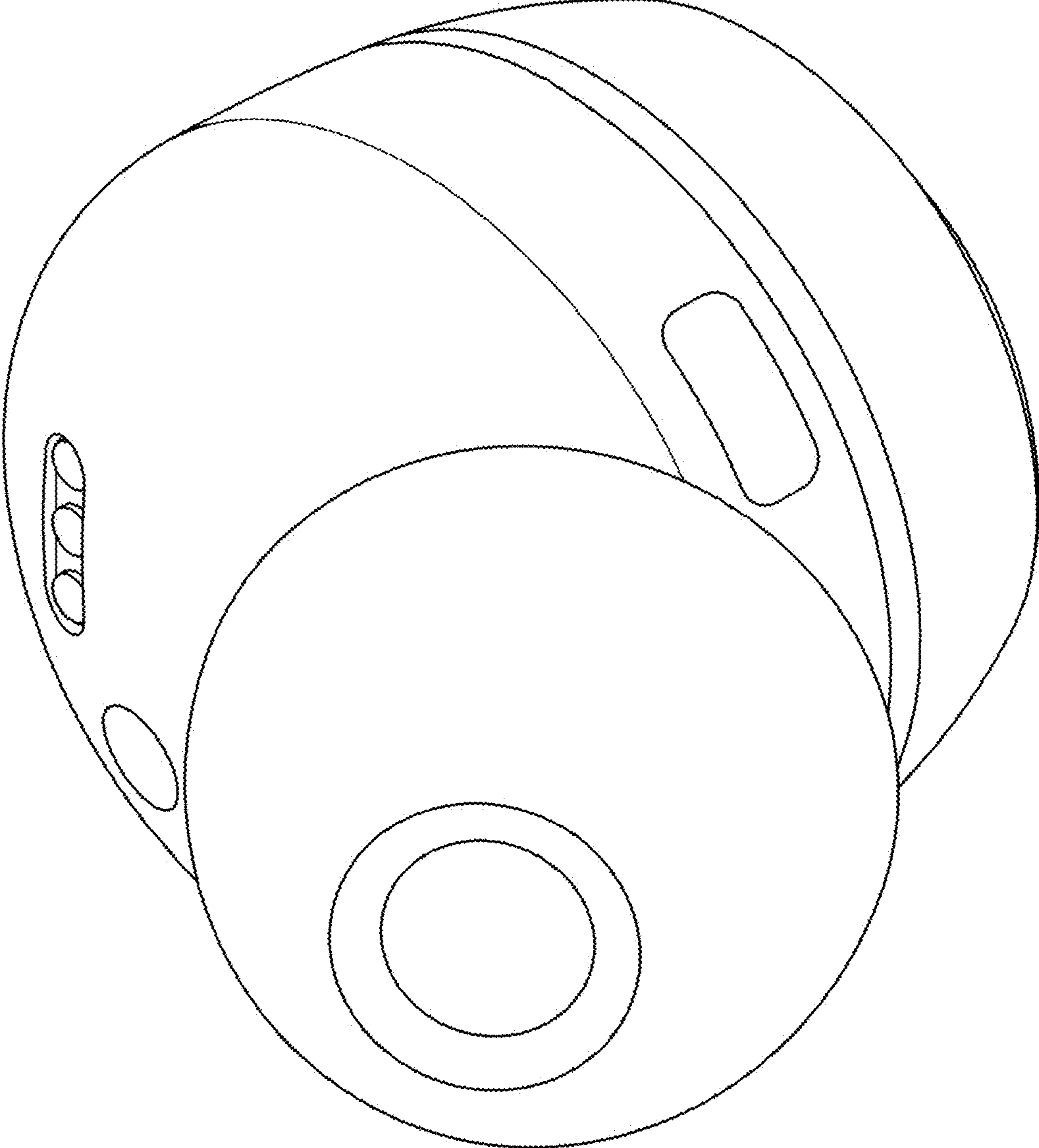
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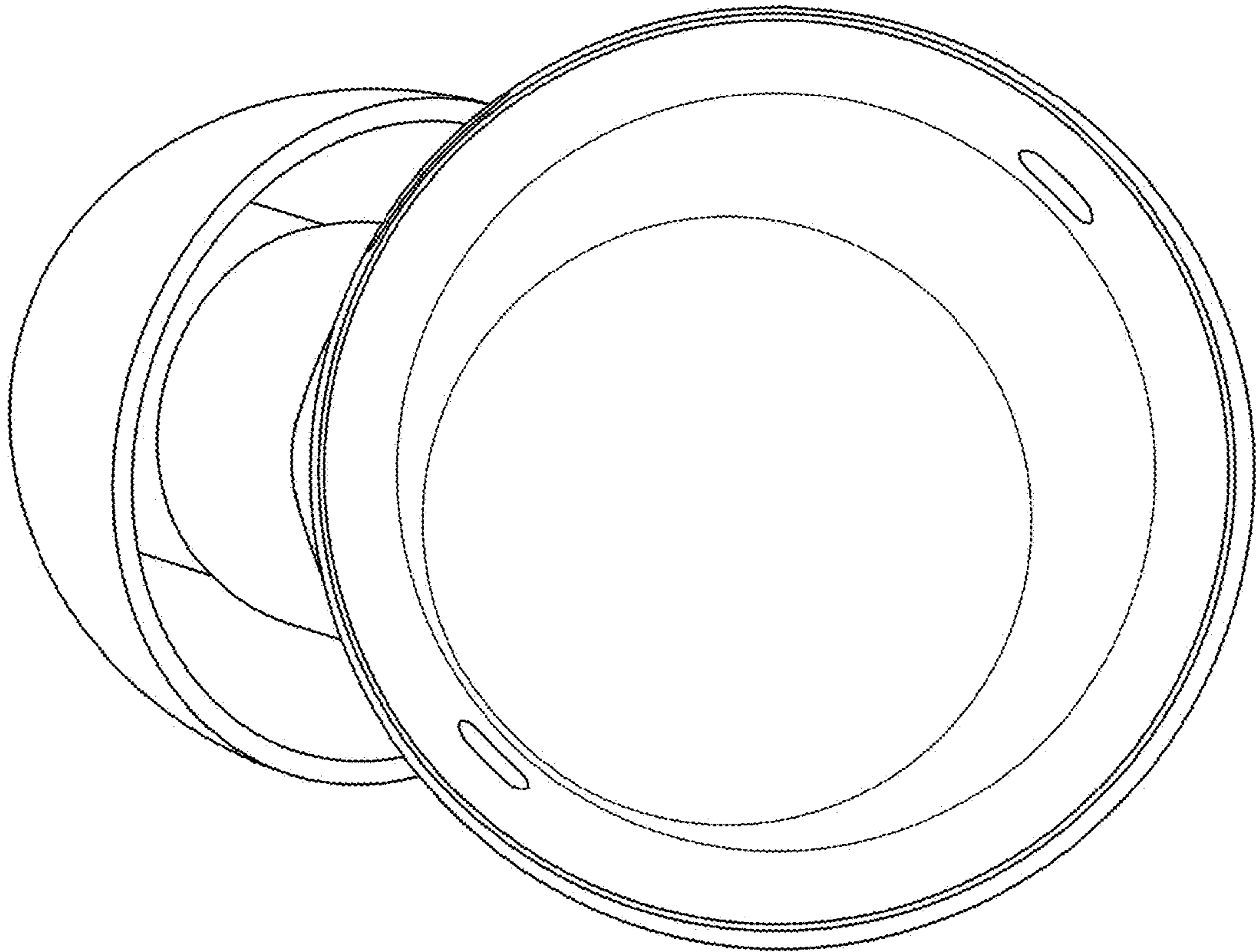
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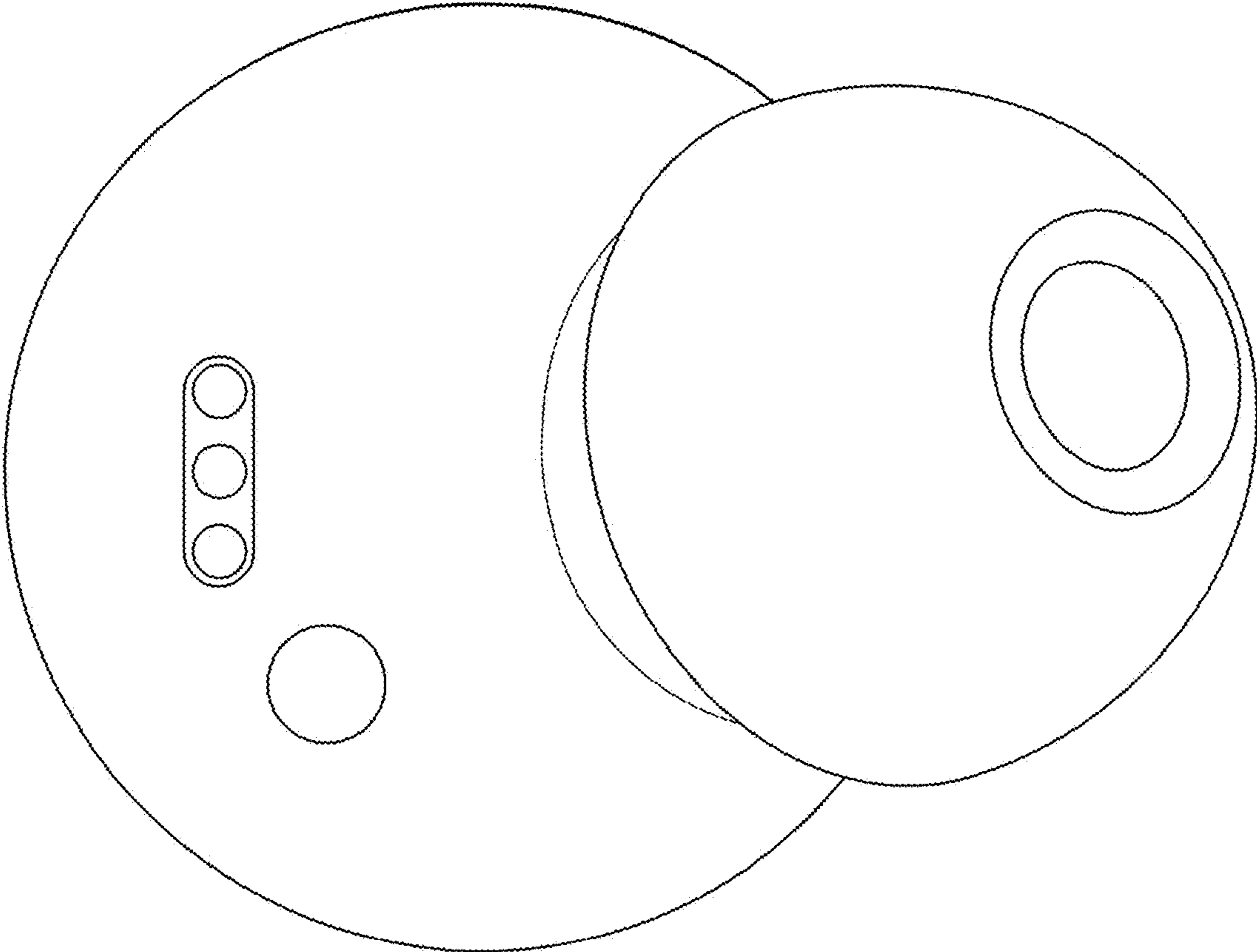
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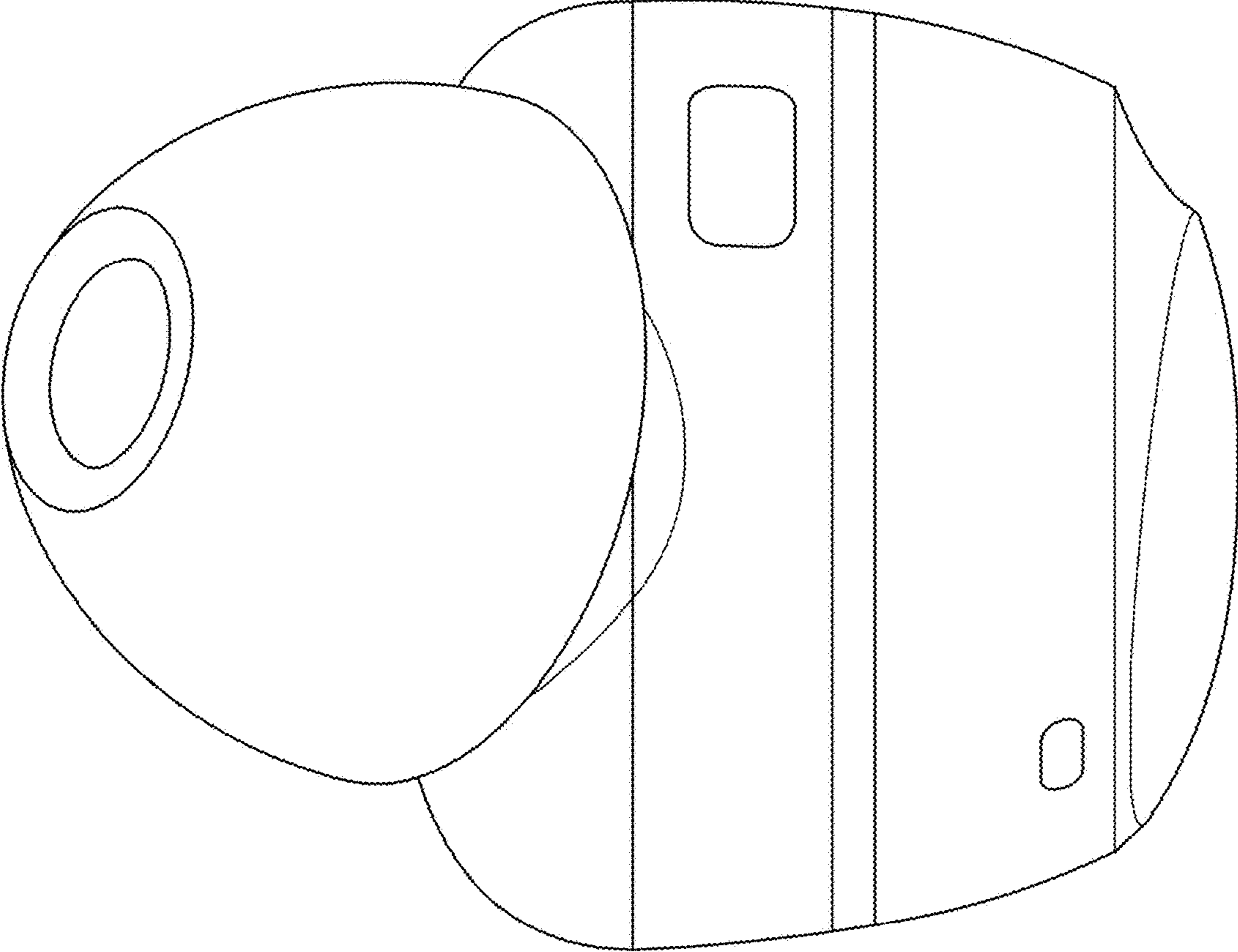
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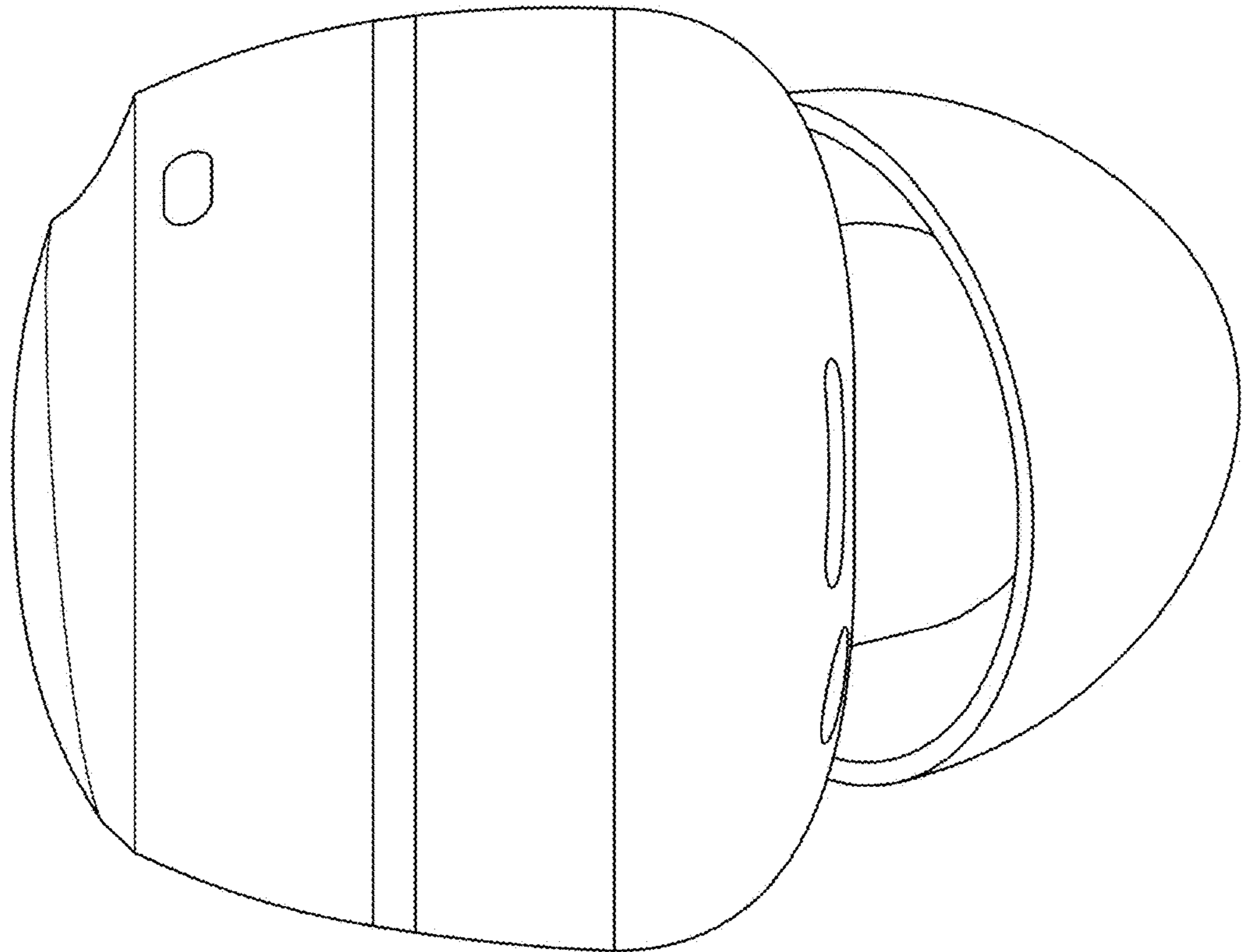
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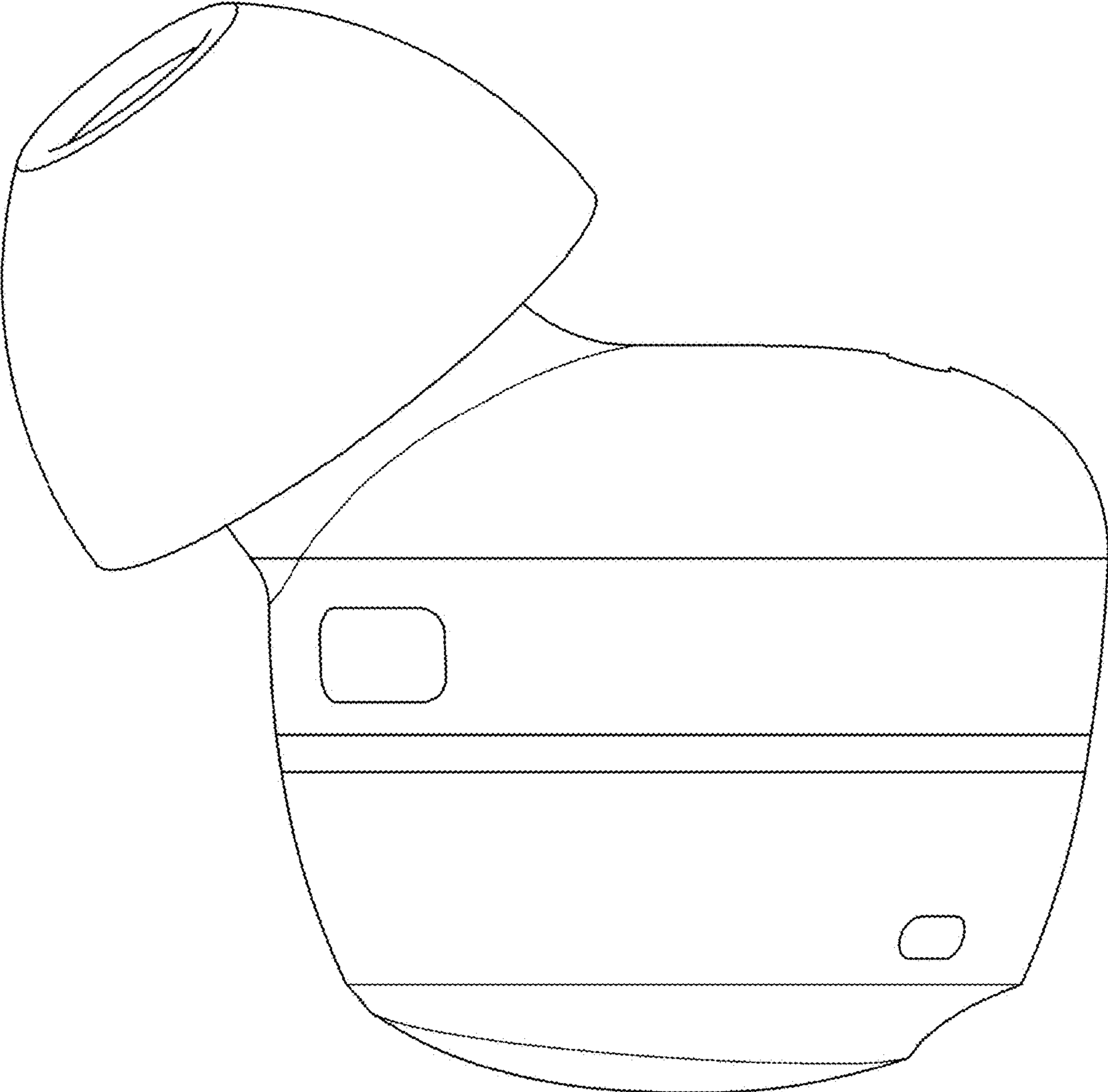
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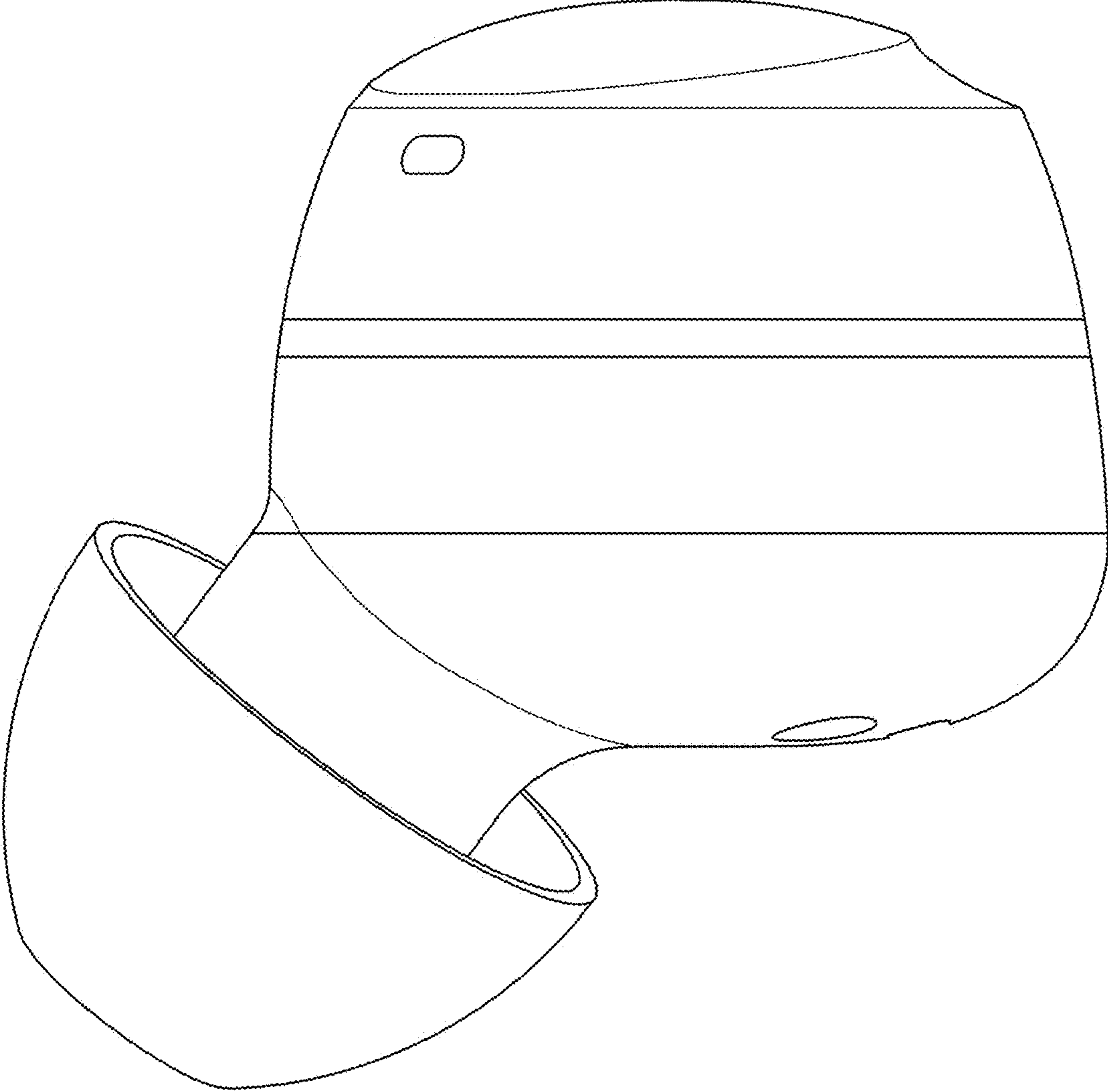
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1.7



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1.9

